

MOSFET

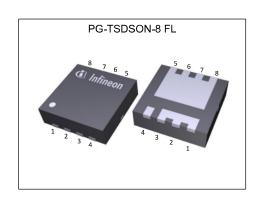
OptiMOS[™] Power-Transistor, 60 V

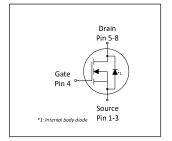
Features

- Optimized for high performance SMPS, e.g. sync. rec.
- 100% avalanche testedSuperior thermal resistance
- N-channel
- Qualified according to JEDEC¹⁾ for target applications
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

Key Performance Parameters Table 1

Parameter	Value	Unit
V _{DS}	60	V
R _{DS(on),max}	10	mΩ
I _D	46	A
Qoss	14	nC
Q _G (0V10V)	12	nC











Type / Ordering Code	Package	Marking	Related Links
BSZ100N06NS	PG-TSDSON-8 FL	100N06N	-

OptiMOS[™] Power-Transistor, 60 V BSZ100N06NS



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OptiMOS[™] Power-Transistor, 60 V BSZ100N06NS



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Paramatan.	Currele el	Values				N (T (O)
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	ID	-	- - -	46 29 11	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =60K/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	184	Α	T _C =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	19	mJ	I_D =20 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	36 2.1	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 K/W ²⁾
Operating and storage temperature	$T_{\rm j},~T_{ m stg}$	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

2 Thermal characteristics

Table 3 Thermal characteristics

Dougnator	Symphol	Values			l lmi4	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R_{thJC}	_	2.1	3.5	K/W	-
Device on PCB, 6 cm² cooling area²)	R _{thJA}	_	-	60	K/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed. as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

³⁾ See Diagram 3 for more detailed information⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	0		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	60	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	2.1	2.8	3.3	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=14\ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	8.5 12.4	10 15	mΩ	V _{GS} =10 V, I _D =20 A V _{GS} =6 V, I _D =5 A
Gate resistance	R _G	-	1.1	1.7	Ω	-
Transconductance	g_{fs}	16	33	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 20 A$

 Table 5
 Dynamic characteristics

Davameter	Cumb al	Values			Unit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance ¹⁾	C _{iss}	-	860	1075	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz	
Output capacitance ¹⁾	Coss	-	210	263	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz	
Reverse transfer capacitance ¹⁾	C _{rss}	-	16	32	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	6	-	ns	$V_{\rm DD} = 30 \text{ V}, V_{\rm GS} = 10 \text{ V}, I_{\rm D} = 20 \text{ A}, R_{\rm G,ext} = 1.6 \Omega$	
Rise time	t _r	-	2	-	ns	$V_{\rm DD} = 30 \text{ V}, V_{\rm GS} = 10 \text{ V}, I_{\rm D} = 20 \text{ A}, R_{\rm G,ext} = 1.6 \Omega$	
Turn-off delay time	$t_{ m d(off)}$	-	10	-	ns	$V_{\rm DD} = 30 \text{ V}, V_{\rm GS} = 10 \text{ V}, I_{\rm D} = 20 \text{ A}, R_{\rm G,ext} = 1.6 \Omega$	
Fall time	t _f	-	2	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω	

Gate charge characteristics²⁾ Table 6

Parameter	Surah al	Values			11	Note / Took Condition
	Symbol	Min.	Typ.	Max.	Unit	Note / Test Condition
Gate to source charge	Q_{gs}	-	4.1	-	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	2.4	-	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	2.5	3.7	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	4.2	-	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate charge total ¹⁾	Qg	-	12	15	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.8	-	V	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	10	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Q _{oss}	-	14	19	nC	V _{DD} =30 V, V _{GS} =0 V

Defined by design. Not subject to production test See "Gate charge waveforms" for parameter definition

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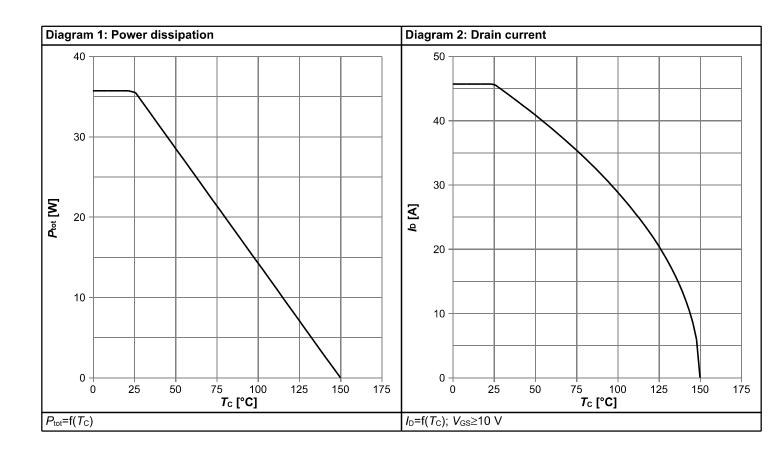
Table 7 Reverse diode

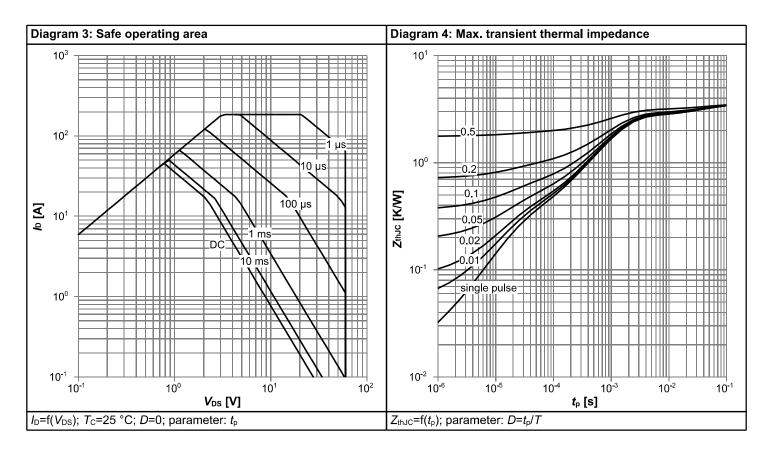
Parameter	Symbol	Values			11:4	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	<i>I</i> s	-	-	30	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	184	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.92	1.2	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	33	53	ns	V _R =30 V, I _F =20 A, di _F /dt=100 A/μs
Reverse recovery charge	Q _{rr}	-	30	-	nC	V _R =30 V, I _F =20 A, di _F /dt=100 A/μs

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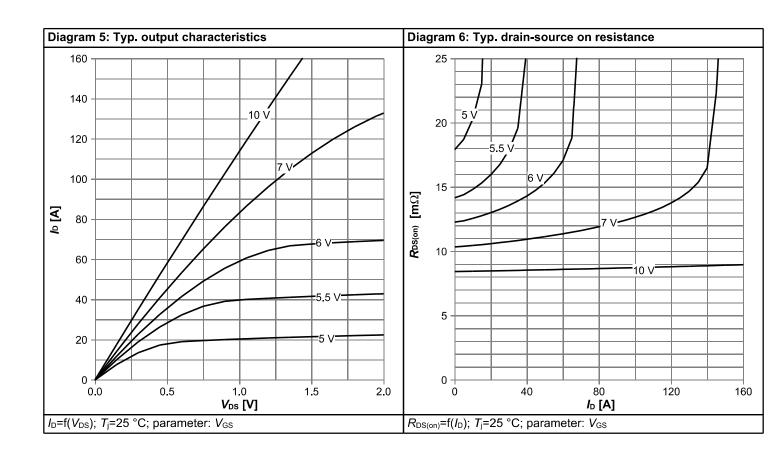


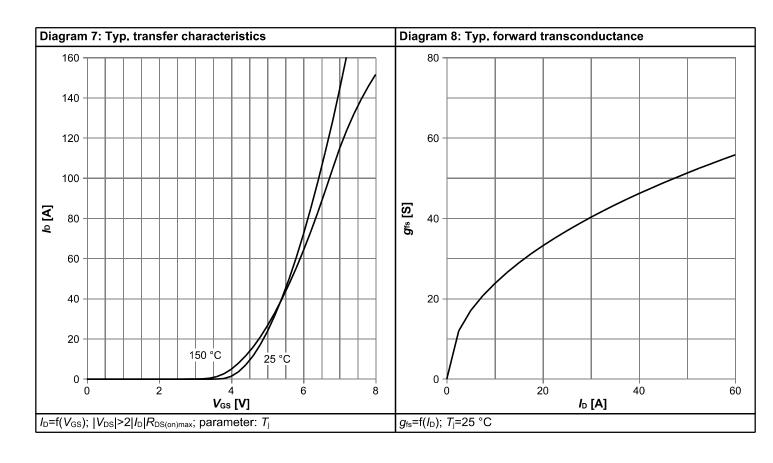
4 Electrical characteristics diagrams



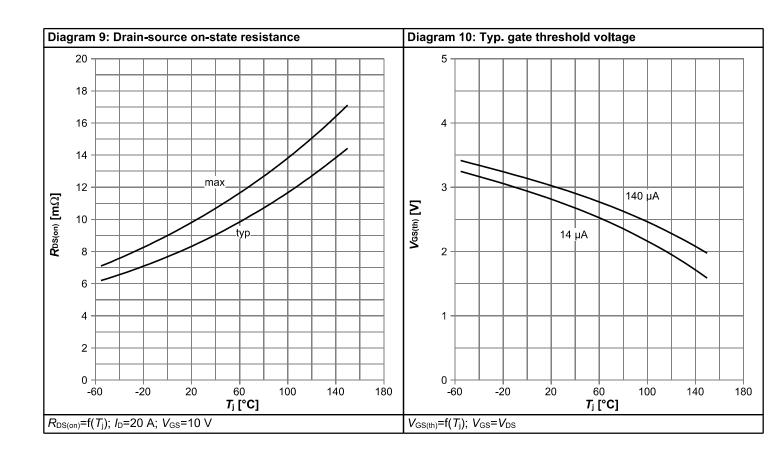


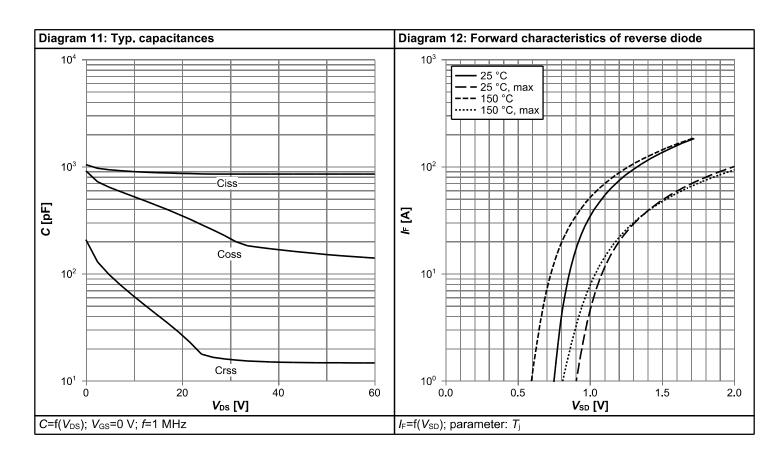




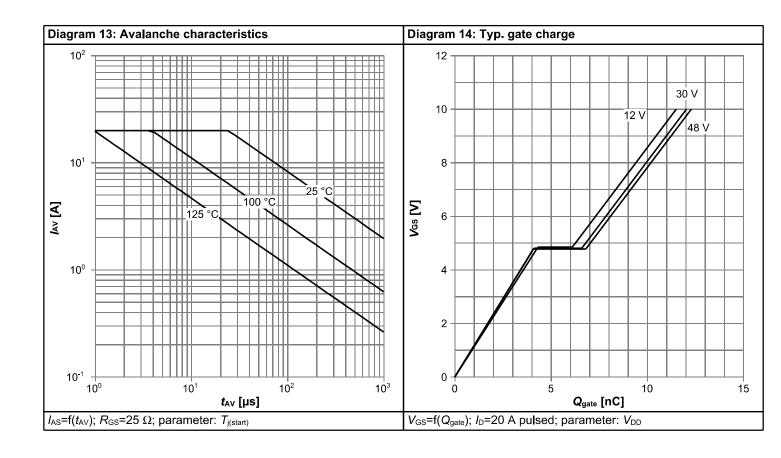


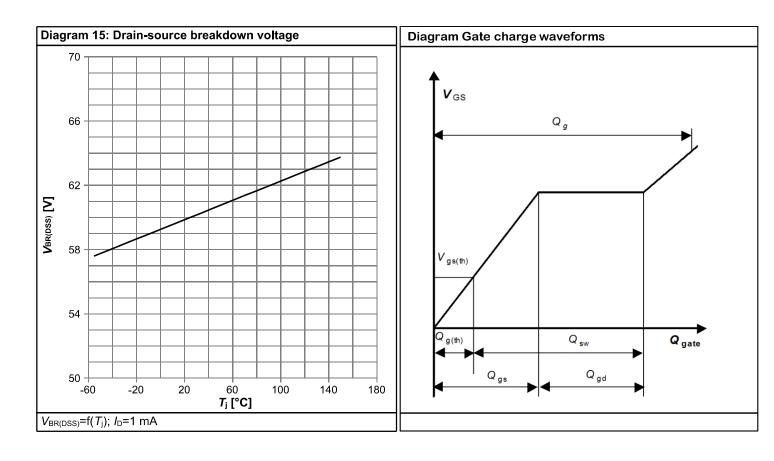






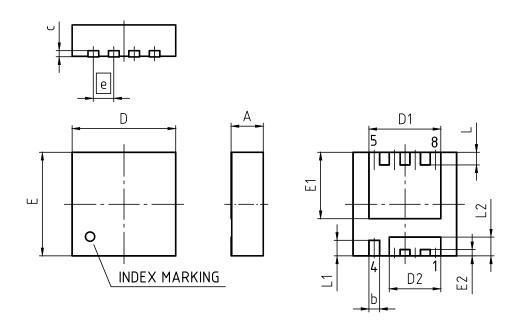








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TSDSON-8-U03					
REVISION: 03	DATE	: 20.10.2020				
DIMENSIONS	MILLI	METERS				
DIMENSIONS	MIN.	MAX.				
Α	0.90	1.10				
b	0.24	0.44				
С	(0).20)				
D	3.20	3.40				
D1	2.19	2.39				
D2	1.54	1.74				
E	3.20	3.40				
E1	2.01	2.21				
E2	0.10	0.30				
е	0.65					
L	0.30	0.50				
L1	0.40	0.60				
L2	0.50	0.70				
aaa	0	.06				

Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm

OptiMOS[™] Power-Transistor, 60 V BSZ100N06NS



Revision History

BSZ100N06NS

Revision: 2021-05-12, Rev. 2.2

Previous Revision

Revision Date Subjects (major changes since last revision)					
2.1	2021-04-16	Update POD, footnotes and addition RthJC typ and Qoss max			
2.2	2021-05-12	Update current rating			

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